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02/17/2011

Page 1 of 1

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Filing Type: **Financing Statement**

File Date: **02/11/2011**

File Time: **16:10**

Filing Number: **11-7260950859**

Lapse Date: **02/11/2016**

Debtor(s):

ORGANIZATION

SEMIQUEST, INC.

2363 BERING DRIVE SAN JOSE CA USA 95131

Secured Party(ies):

ORGANIZATION

3M INNOVATIVE PROPERTIES COMPANY

P.O. BOX 33428 SAINT PAUL MN USA 55133-3428

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UCC FINANCING STATEMENT

FOLLOW INSTRUCTIONS (front and back) CAREFULLY

11-7260950859

02/11/2011 16:10

A. NAME & PHONE OF CONTACT AT FILER (optional)

B. SEND ACKNOWLEDGMENT TO: (Name and Address)

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Sacramento CA 95811

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1. DEBTOR'S EXACT FULL LEGAL NAME - insert only one debtor name (1a or 1b) - do not abbreviate or combine names

1a. ORGANIZATION'S NAME
SEMIQUEST, INC.

OR

1b. INDIVIDUAL'S LAST NAME

FIRST NAME MIDDLE NAME SUFFIX

1c. MAILING ADDRESS CITY STATE POSTAL CODE COUNTRY

2363 Berling Drive San Jose CA 95131 USA

1d. SEE INSTRUCTIONS ADD'L INFO RE ORGANIZATION DEBTOR 1e. TYPE OF ORGANIZATION 1f. JURISDICTION OF ORGANIZATION 1g. ORGANIZATIONAL ID #, if any

Corporation California C2629984 NONE

2. ADDITIONAL DEBTOR'S EXACT FULL LEGAL NAME - insert only one debtor name (2a or 2b) - do not abbreviate or combine names

2a. ORGANIZATION'S NAME

OR

2b. INDIVIDUAL'S LAST NAME

FIRST NAME MIDDLE NAME SUFFIX

2c. MAILING ADDRESS CITY STATE POSTAL CODE COUNTRY

2d. SEE INSTRUCTIONS ADD'L INFO RE ORGANIZATION DEBTOR 2e. TYPE OF ORGANIZATION 2f. JURISDICTION OF ORGANIZATION 2g. ORGANIZATIONAL ID #, if any

NONE

3. SECURED PARTY'S NAME (or NAME of TOTAL ASSIGNEE of ASSIGNOR(S)) - insert only one secured party name (3a or 3b)

3a. ORGANIZATION'S NAME
3M INNOVATIVE PROPERTIES COMPANY

OR

3b. INDIVIDUAL'S LAST NAME

FIRST NAME MIDDLE NAME SUFFIX

3c. MAILING ADDRESS CITY STATE POSTAL CODE COUNTRY

P.O. Box 33428 St. Paul MN 55133-3428 USA

4. This FINANCING STATEMENT covers the following collateral:

All right, title, interest, claims and demands of Debtor in and to all patents, patent rights (and applications and registrations therefor), trademarks and service marks (and applications and registration therefor), inventions, copyrights, mask works (and applications and registrations therefor), trade names, trade styles, software and computer programs, trade secrets, methods, processes, know how, drawings, specifications and descriptions, including, without limitation, the patent applications described on the attached Patent Applications Schedule.

5. ALTERNATIVE DESIGNATION (if applicable): LESSOR/LESSOR CONSIGNEE/CONSIGNOR BAILEE/BAILOR SELLER/BUYER AS LIEN NON-UCC FILING

6. THIS FINANCING STATEMENT is to be filed (or record) in the REAL ESTATE RECORDS. Attach Addendum (if applicable) 7. Check to REQUEST SEARCH REPORT (S) on Debtor(A) (optional) All Debtors Debtor 1 Debtor 2

8. OPTIONAL FILER REFERENCE DATA

[File with the California Secretary of State (178131/110)] 8071190

PENDING SEMI-REQUEST
PATENT APPLICATIONS

	Title	PCT Application No. (Attorney's Docket No.)	Filing Date	Texas Application No. (Attorney's Docket No.)	Texas Filing Date	Countries Selected
1	Method and Apparatus for Improved Chemical Mechanical Planarization	WO 2000/042010 US Application (40007524-0001-010)	10/5/2005	(40007524-0001-036)	10/5/2005	Taiwan, US, Japan, Singapore, China, Korea, (UK, France,
2	Method and Apparatus for Improved Chemical Mechanical Planarization Pad with Uniform Polish Performance	WO 2000/057714 US Application (40007524-0002-018)	10/5/2005	N/A	N/A	Taiwan, US, Japan, Singapore, China, Korea, (UK, France,
3	Electro-mechanical and apparatus for improved chemical mechanical planarization pad with uniform polish performance	WO 2808/057713 US Application (40007524-0003-010)	10/5/2005	N/A	N/A	Taiwan, US, Japan, Singapore, China, Korea, (UK, France,
4	Method and Apparatus for Improved Chemical Mechanical Planarization Pad with Pressure Control and Process Monitor	WO 2000/057720 US Application (40007524-0004-010)	10/5/2005	(40007524-0004-035)	10/14/2005	Taiwan, US, Japan, Singapore, China, Korea, (UK, France,
5	Electro-chemical Mechanical Planarization Pad with Uniform Polish	US Application (40007524-0005-002)	11/23/2008	-	-	US filing only
6	CMP Pad Design	US Application (40007524-0009-002)	11/23/2008	-	-	US filing only
7	Iterative Pad Assembly Device	Provisional US Application 60926,244	Foreign Filing Priority 04/27/2007	N/A	N/A	N/A
8	Method of Removal Profile Modulation in CMP Pads	Provisional US Application 60926,243	Foreign Filing Priority 04/28/2007	N/A	N/A	N/A
9	Polishing Pad and Method of Use	US Application 11676,304 (40007524-0011-052)	8/28/2007	N/A	N/A	N/A
10	Polishing Pad	Provisional US Application 60936984	9/3/2007	N/A	N/A	N/A
11	Chemical Mechanical Planarization Pad and Method of Use Thereof	US CIP Application 11/0365,442	1/2/2008	N/A	N/A	N/A
12	Polishing Pad with Endpoint Window and Systems and Method of Using the Same	Provisional US Application 61065,429 (64194US022)	5/15/2008	N/A	N/A	N/A

RECORDATION DATE: 12/15/2008

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BRIEF: SECURITY AGREEMENT
DOCKET NUMBER: 3M

ASSIGNOR:
SEMIQUEST, INC.

DOC DATE: 08/31/2007

ASSIGNEE:
3M IPC
3M CENTER
BUILDING 0220-09-E-02
ST. PAUL, MINNESOTA 55144-1000

SERIAL NUMBER: 60926244
PATENT NUMBER:
TITLE: INTERACTIVE PAD ASSEMBLY DEVICE

FILING DATE: 04/26/2007
ISSUE DATE:

SERIAL NUMBER: 60926243
PATENT NUMBER:
TITLE: METHOD OF REMOVAL PROFILE MODULATION IN CMP PADS

FILING DATE: 04/26/2007
ISSUE DATE:

SERIAL NUMBER: 11846304
PATENT NUMBER:
TITLE: POLISHING PAD AND METHOD OF USE

FILING DATE: 08/28/2007
ISSUE DATE:

SERIAL NUMBER: 60969684
PATENT NUMBER:
TITLE: POLISHING PAD

FILING DATE: 09/03/2007
ISSUE DATE:

SERIAL NUMBER: 11968442
PATENT NUMBER:
TITLE: CHEMICAL MECHANICAL PLANARIZATION PAD AND METHOD OF USE THEREOF.

FILING DATE: 01/02/2008
ISSUE DATE:

SERIAL NUMBER: 61053429
PATENT NUMBER:
TITLE: POLISHING PAD WITH ENDPOINT WINDOW AND SYSTEMS AND METHOD USING THE SAME

FILING DATE: 05/15/2008
ISSUE DATE:

SERIAL NUMBER:
PATENT NUMBER:
PCT NUMBER: WO0642010
TITLE:

FILING DATE:
ISSUE DATE:

SERIAL NUMBER:
PATENT NUMBER:
PCT NUMBER: WO0657714
TITLE:

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PATENT NUMBER:
PCT NUMBER: WO0657713
TITLE:

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SERIAL NUMBER:
PATENT NUMBER:
PCT NUMBER: WO0657720
TITLE:

FILING DATE:
ISSUE DATE:

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